

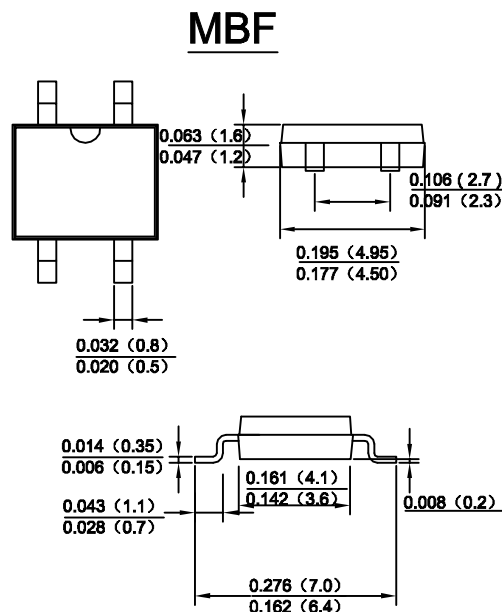


Features

- Glass passivated die construction
- Low forward voltage drop
- High current capability
- High surge current capability
- Designed for surface mount application
- Plastic material-UL flammability 94V-0

Mechanical Data

- Case: MB-F, molded plastic
- Terminals: plated leads solderable per MIL-STD-202, Method 208
- Polarity: as marked on case
- Mounting position: Any
- Marking: type number
- Lead Free: For RoHS / Lead Free Version,



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single Phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

TYPE NUMBER	SYMBOL	MB10F-50	UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	1000	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_{DC}		
RMS Reverse Voltage	V_{RMS}	700	V
Maximum average forward rectified current @ $T_A=40^\circ\text{C}$	I_O	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	35	A
Forward Voltage per element @ $I_F=1.0\text{A}$	V_{FM}	1.1	V
Peak Reverse Current @ $T_A=25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_A=125^\circ\text{C}$	I_R	5.0 500	μA
Typical Junction Capacitance per leg (Note 1)	C_J	25	pF
Typical Thermal Resistance per leg (Note 2)	$R_{\theta JA}$	60	$^\circ\text{C/W}$
	$R_{\theta JL}$	16	
Operating and Storage Temperature Range	T_J, T_{STG}	-55to+150	$^\circ\text{C}$

Note:1. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

2. Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B with 0.5×0.5"(13×13mm)copper pads.



Fig. 1 Output Current Derating Curve

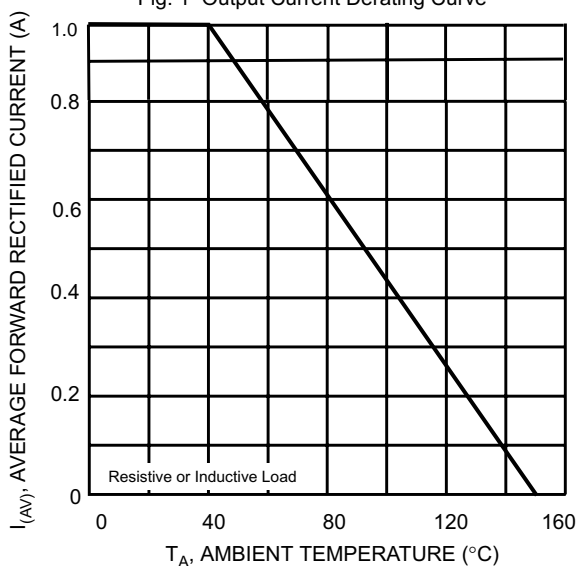


Fig. 2 Typical Forward Characteristics (per leg)

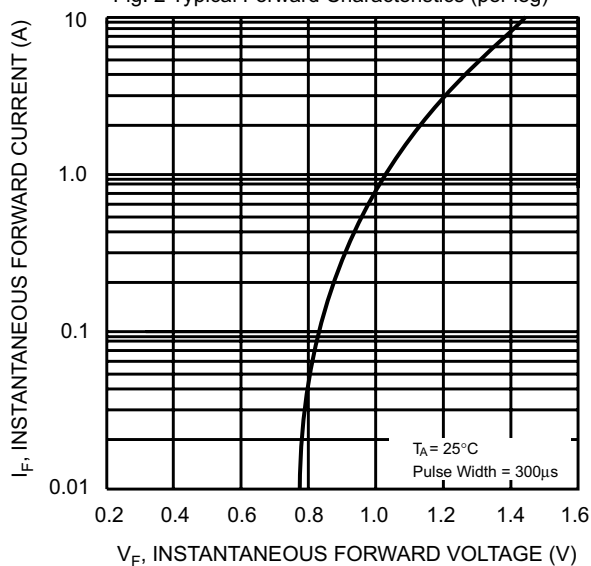


Fig. 3 Maximum Peak Forward Surge Current (per leg)

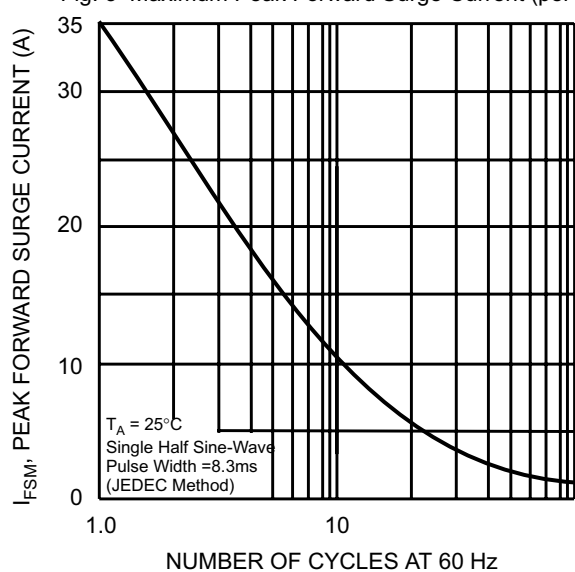


Fig. 4 Typical Junction Capacitance

